



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

P/N: KCDC02-127

GREEN

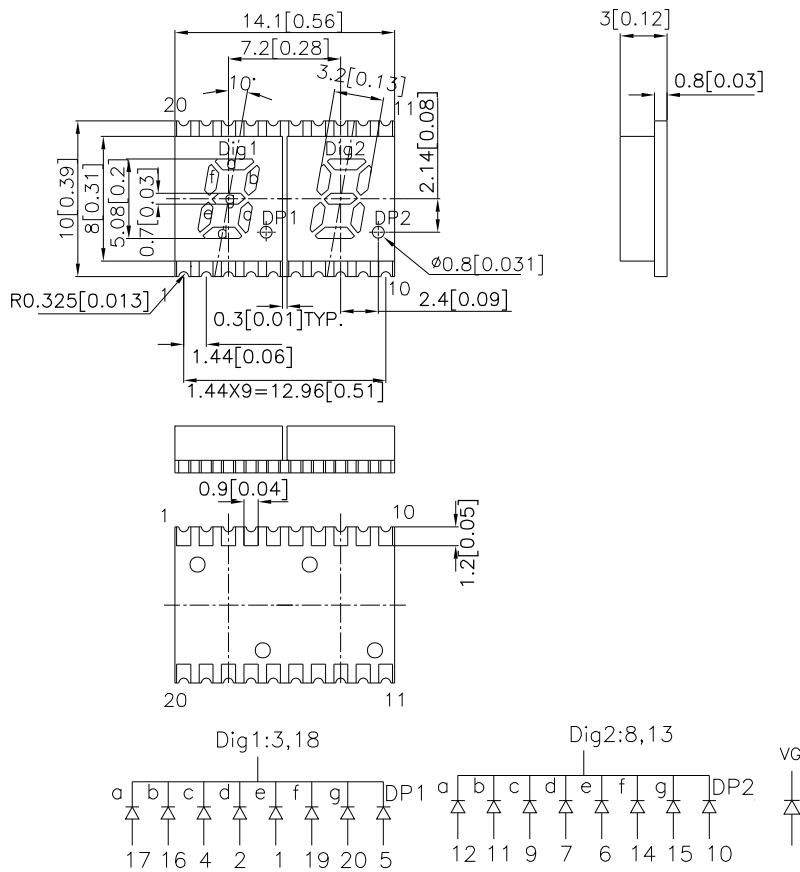
Features

- 0.2 INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- PACKAGE :300PCS / REEL.
- GRAY FACE, WHITE SEGMENT.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

Description

The Green source color devices are made with InGaN on SiC Light Emitting Diode.
Static electricity and surge damage the LEDs.
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
All devices, equipment and machinery must be electrically grounded.

Package Dimensions & Internal Circuit Diagram



Notes:

1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
2. Specifications are subject to change without notice.
3. The gap between the reflector and PCB shall not exceed 0.25mm.

Selection Guide

Part No.	Dice	Lens Type	I _V (ucd) [1] @ 10mA		Description
			Min.	Typ.	
KCDC02-127	GREEN (InGaN)	WHITE DIFFUSED	8000	31320	Common Cathode, Rt. Hand Decimal.

Notes:

1. Luminous Intensity / Luminous Flux: +/-15%.

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	520		nm	I _F =20mA
λD [1]	Dominant Wavelength	Green	525		nm	I _F =20mA
Δλ1/2	Spectral Line Half-width	Green	38		nm	I _F =20mA
C	Capacitance	Green	45		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Green	3.5	4.5	V	I _F =20mA
I _R	Reverse Current	Green		10	uA	V _R = 5V

Notes:

1. Wavelength: +/-1nm.

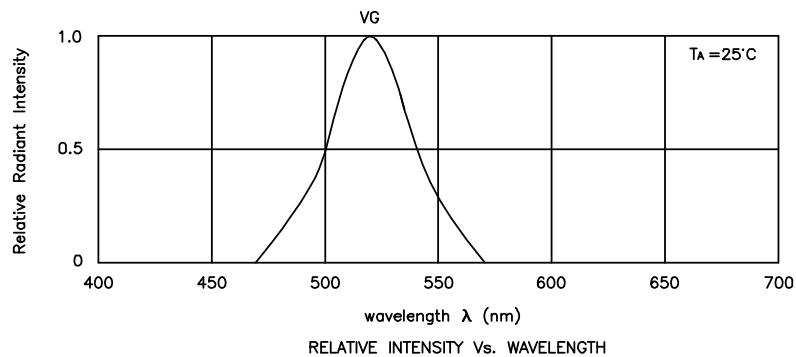
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at T_A=25°C

Parameter	Green	Units
Power dissipation	135	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

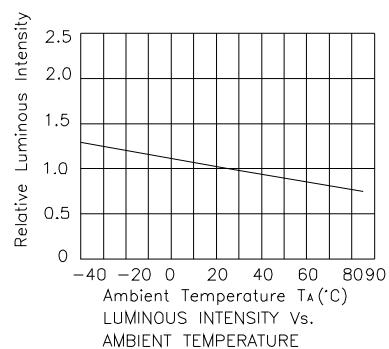
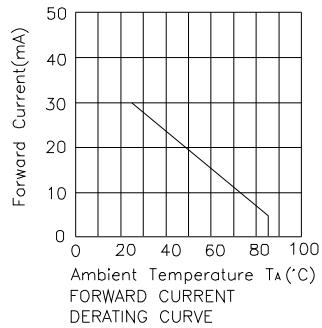
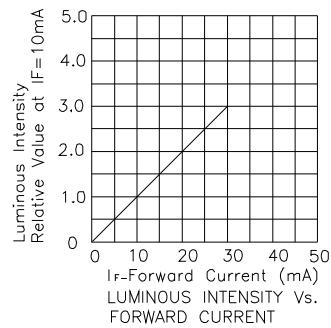
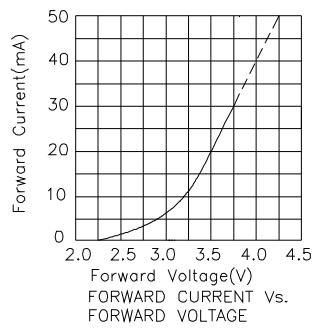
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



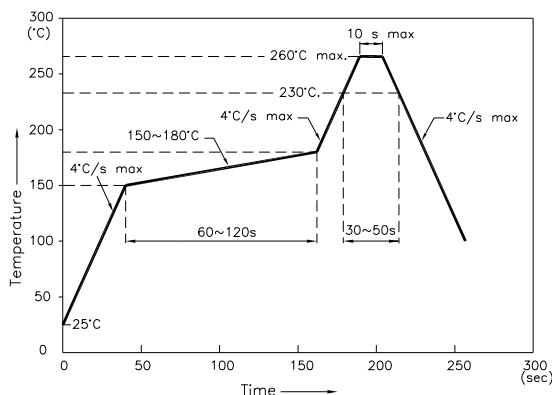
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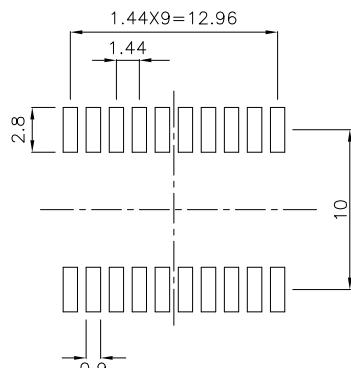
Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

1. We recommend the reflow temperature $245^{\circ}\text{C} (+/- 5^{\circ}\text{C})$. The maximum soldering temperature should be limited to 260°C .
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm)



Tape Specifications (Units : mm)

